

[illegible]

FIG.3

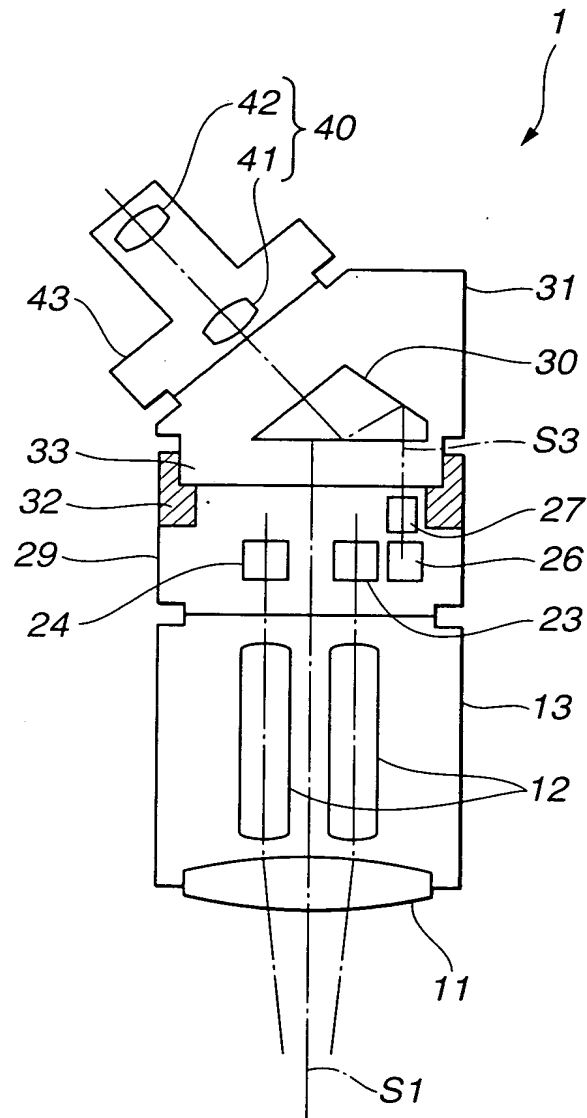


FIG.4

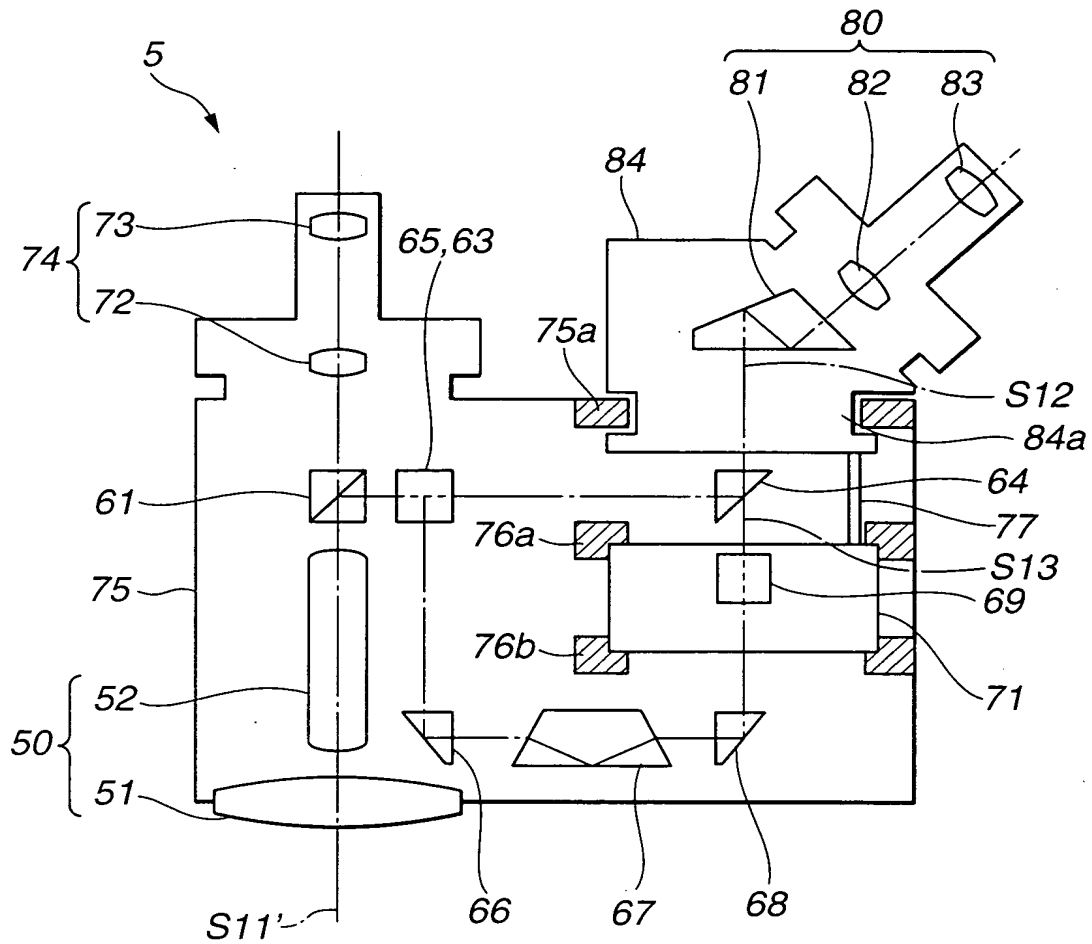


FIG.5

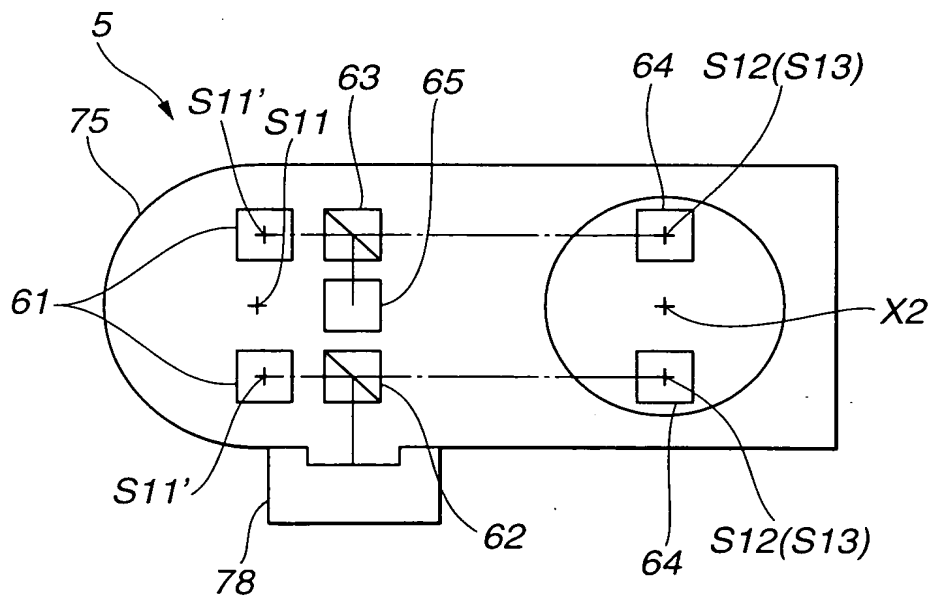


FIG.6

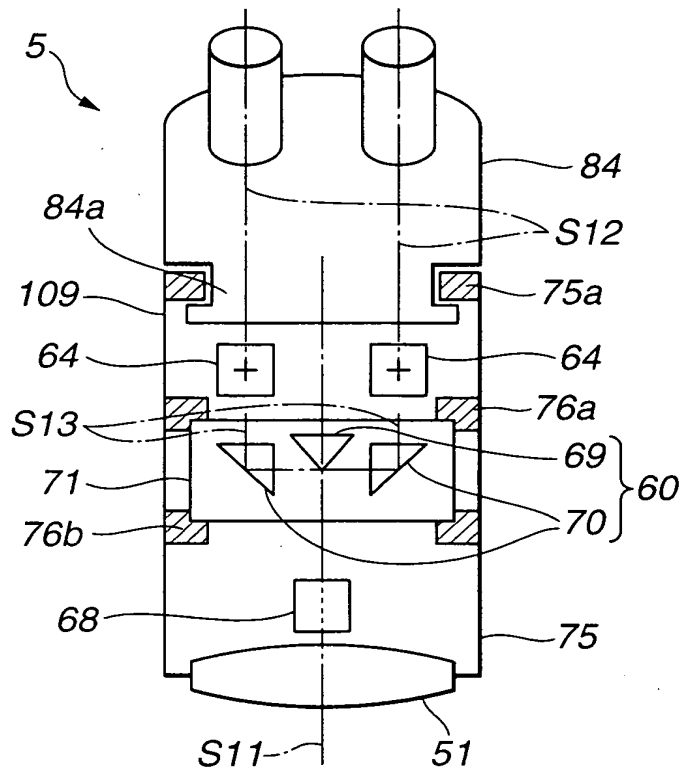


FIG.7

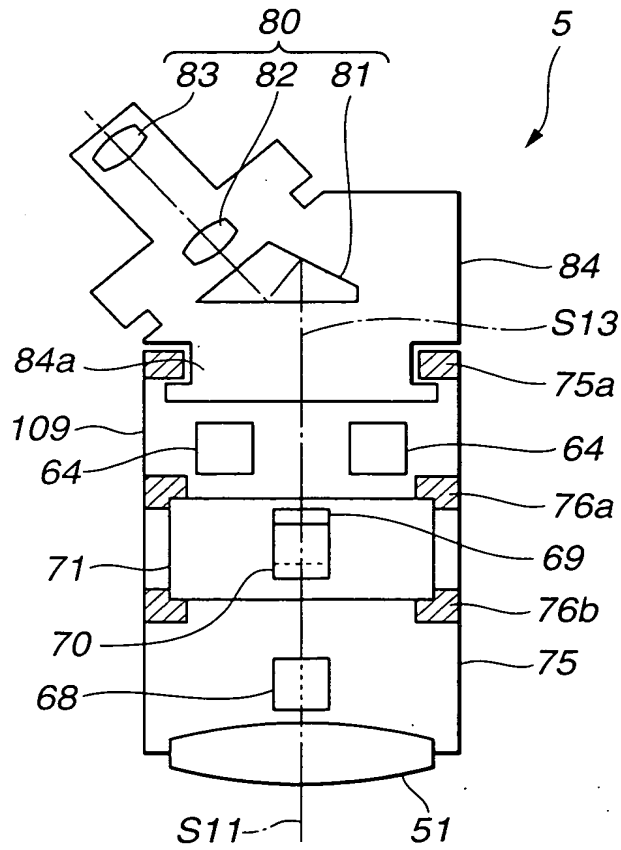


FIG.8

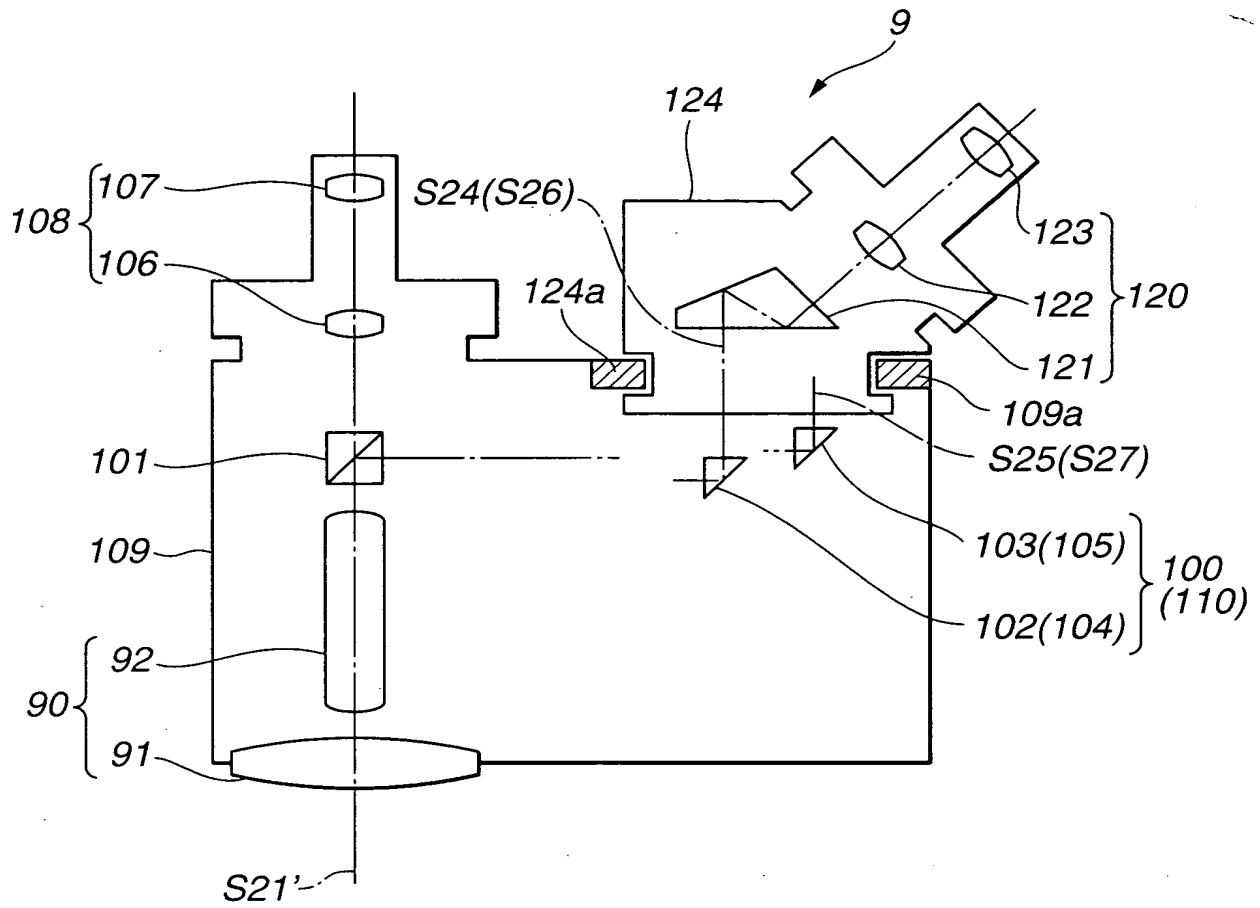


FIG.9

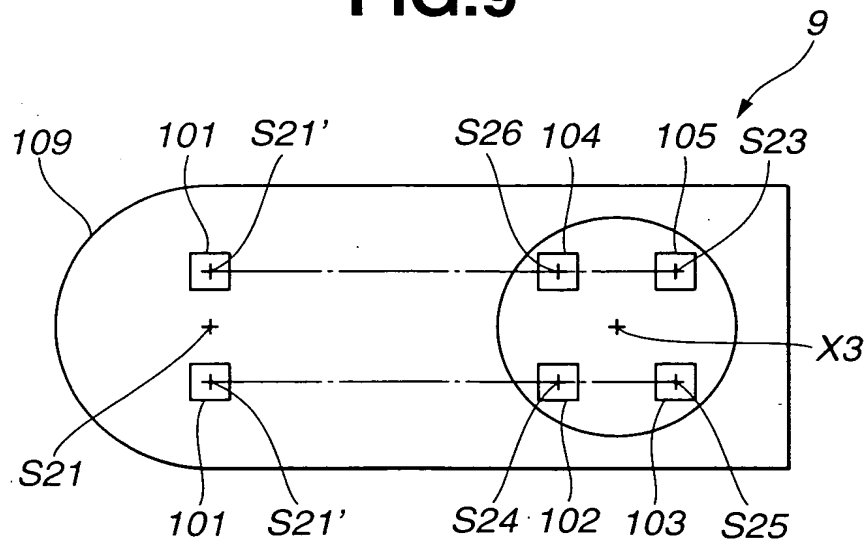
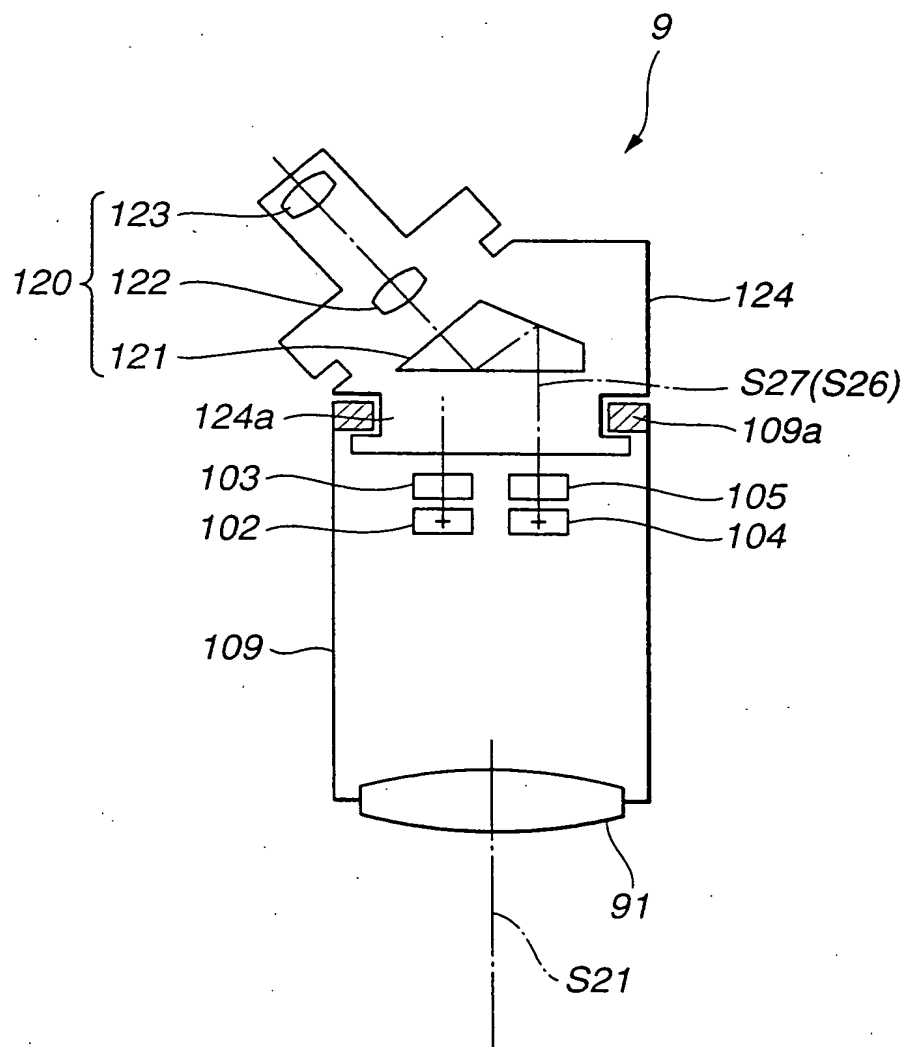


FIG.10



A detailed cross-sectional diagram of a device assembly labeled 1. The assembly consists of several stacked layers and components:

- Top Layer (40A):** Includes a central lens-like element 41, flanked by side elements 42, all mounted on a base 43A.
- Middle Section:** Features a complex arrangement of optical or electronic components. It includes a layer 30 with a patterned surface 31. Below this are layers 32 and 33. A component S2 is shown as a hatched rectangular block. To the right, another hatched block 34 is positioned above a layer 35a. A series of small triangles 27 and 28 are arranged in a row, with a bracket 20 indicating their collective function. Above them, a component S3 is indicated.
- Bottom Layer (10):** Consists of a large rectangular frame 13 containing a vertical cylindrical element 12. At the very bottom is a lens-like element 11. This entire section is collectively labeled 10.
- Other Labels:** 130 points to two square features with diagonal lines. 131, 132, and 133 point to various internal structures or interfaces. 43B points to a tilted structural element on the right. S1' is at the bottom center, and S3 is near the top right.

FIG.13

